

A Product Line of Diodes Incorporated



SPECIFICATION FOR APPROVAL

CUSTOMER

NOMINAL FREQUENCY

24.000000 MHz

PRODUCT TYPE

SPEC. NO. (P/N)

FL2400220Q

TYPE FL 3.2x2.5 SEAM SEALED CRYSTAL

CUSTOMER P/N

ISSUE DATE

VERSION

March 6, 2018

В

APPROVED	PREPARED	QA
Brenda	Claire	Dong Jang

Diodes Incorporated

No.2, Ziqiang 5th Rd., Zhongli Industrial Park, Zhongli Dist., Taoyuan City 32063, Taiwan (R.O.C.) TEL: 886-3-451-8888 FAX: 886-3-461-3865 https://www.diodes.com

*Pb-free

*RoHS Compliant

*HF-Halogen Free

***REACH Compliant**

*AEC-Q200 Compliant

TYPE FL 3.2x2.5 SEAM SEALED CRYSTAL

FL2400220Q

VER. B 6-Mar-18

VERSION HISTORY

Version No.	Version Date	Description	Notes	
A Mar.2,2018		Initial Release		
В	Mar.6,2018	1.Removed stability ±10ppm@0~85°C 2.Updated stability from ±50ppm@-40~105°C to ±50ppm@-40~125°C 3.Updated Operating Temperature Range to -40~125°C		



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ELECTRICAL SPECIFICATIONS

Item	Symbol	Specifications	Units	Notes
Nominal Frequency	Fn	24.000000	MHz	
Mode of Oscillation	MO	AT Cut-Fundamental		
Calibration Load Capacitance	CL	18	pF	
Calibration Tolerance	FL	±10	ppm	at 25°C±3°C
Operating Temperature Range	TR	-40 to +125	°C	
Frequency Stability (-40°C to +125°C)	F/T	±50	ppm	Reference to the Frequency at 25°C
Operating Drive Level		10	μW	
Maximum Drive Level		100	μW	
Equivalent Series Resistance	ESR	60	Ω	Мах
Shunt Capacitance	C0	5	pF	Мах
Aging at 25°C		±3	ppm	Max, 1st year
Storage Temperature		-55 to +125	°C	
Insulation Resistance		500	MΩ	Min

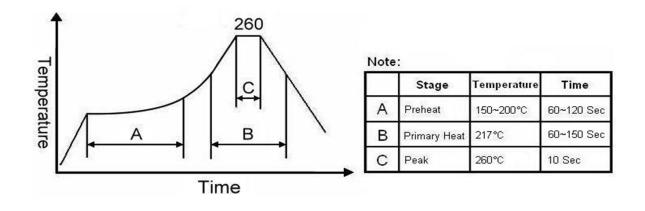


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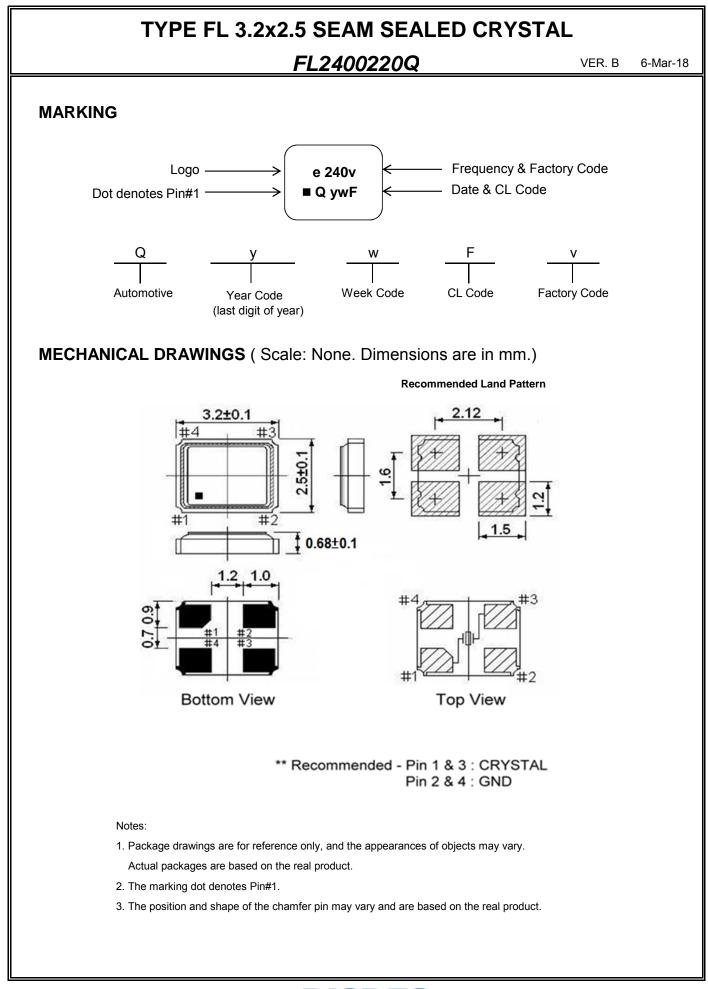
FL2400220Q

AEC-Q200 RELIABILITY TEST SPECIFICATIONS: 1. Initial 1.1 Physical Dimensions: JESD22, Method JB1-100 1.2 External Visual: MIL-STD-883, Method 2009 1.3 Freq. Vs. Temperature: Per Specification/Datasheet 2. Mechanical 2.1 Mechanical Shock: MIL-STD-202 Method 213 2.2 Vibration: MIL-STD-202 Method 204 2.3 Solderability: J-STD-002 2.4 Board Flex: AEC Q200-005 2.5 Terminal Strength (SMD): AEC Q200-006 3.Environmental 3.1 Temp Cycle: JESD22, Method JA-104 3.2 Resistance to Solder Heat: MIL-STD-202 Method 210 3.3 High Temperature Operating Life: MIL-STD-202, Method 108 3.4 High Temp Exposure: MIL-STD-202, Method 108 3.5 High Temp & High Humidity: MIL-STD-202, Method 103 3.6 Thermal Shock: MIL-STD-202, Method 107 SUGGESTED IR REFLOW PROFILE

*As per IPC-JEDEC J-STD-020D



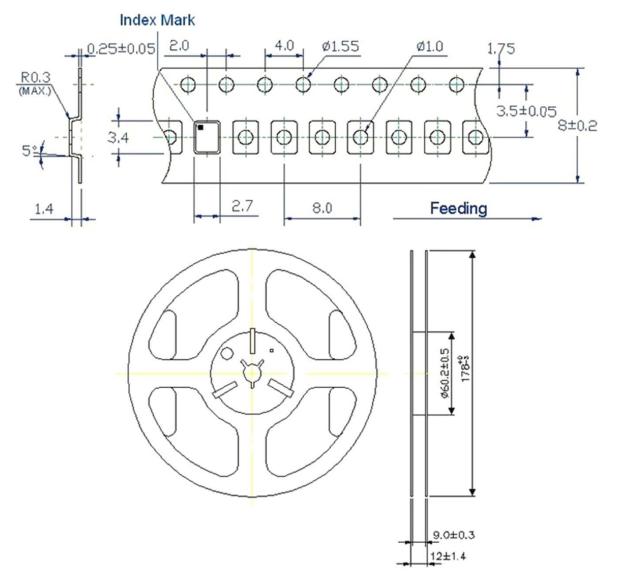






TYPE FL 3.2x2.5 SEAM SEALED CRYSTAL FL2400220Q VER. B 6-Mar-18

Tape & Reel



- 1. 230mm minimum leafer which consist of carrier and/or tape followed by a minimum of 160mm of empty carrier tape sealed with cover tape.
- 2. 160mm minimum trailer of empty carrier tape sealed with cover tape.



